

	Type	L #	Hits	Search Text	DBs
1	IS&R	L1	324	((338/12) or (338/128)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
2	IS&R	L2	0	("(circuitadjboard)orPCB").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
3	BRS	L3	32065 4	(circuit adj board) or PCB	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
4	BRS	L4	17522 2	pressure with sensor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
5	BRS	L6	19	5 same integral	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
6	BRS	L5	1091	3 with 4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
7	BRS	L7	7	FSR and 5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
8	BRS	L8	146	membrane and 5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
9	BRS	L9	3	SP-7533 or ML25184	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
10	BRS	L10	24513	adhesive with ink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
11	BRS	L11	1	10 and 8	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
12	BRS	L12	4	10 and 5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
13	BRS	L13	1697	adhesive adj ink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
14	BRS	L14	44977 38	pressure or force	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
15	BRS	L15	771	13 and 14	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
16	BRS	L16	21668 9	(pressure or force) with sensor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
17	BRS	L17	8	13 and 16	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
18	BRS	L18	25697	338/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
19	BRS	L19	2	13 and 18	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
20	BRS	L21	5	20 and 16	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
21	BRS	L20	742	adhesive with ink with screen	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
22	BRS	L22	1697	adhesive adj ink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
23	BRS	L23	47	22 with screen	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
24	BRS	L24	235	oxidation with preventing with conductive with layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB